Innovating Energy Technology

FML60N093S2FDHF

http://www.fujielectric.com/products/semiconductor/

FUJI POWER MOSFET

Super J MOS® S2 series

N-Channel enhancement mode power MOSFET

Features

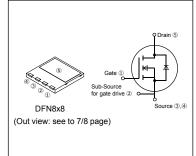
Pb-free lead terminal RoHS compliant Halogen-free molding compound MSL:1, Reflow available

Applications

For switching



Package and Internal circuit chart



■ Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Ducin Source Voltage	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Continuous Drain Current	,	42.3	Α	T _c =25°C Note*1,2
Continuous Drain Current	/ D	26.8	Α	T _c =100°C Note*1,2
Pulsed Drain Current	I DP	125.6	Α	Note *2
Gate-Source Voltage	V _{GS}	±30	V	
Non-Repetitive Maximum Avalanche Current	I AS	5.5	А	Note *3
Non-Repetitive Maximum Avalanche Energy	E AS	964.2	mJ	Note *4
Maximum MOSFET dv/dt	d <i>v</i> ⊳s/d <i>t</i>	50	V/ns	V _{DS} ≤ 600V
Continuous	,	42.3	Α	T _c =25°C Note*1,2
Diode Forward Current	I DR	26.8	Α	T _c =100°C Note*1,2
Pulsed Diode Forward Current	I DRP	125.6	Α	Note *2
Peak Diode Recovery dv/dt	dv/dt	30	V/ns	Note *5
Peak Diode Recovery -didr/dt	-d <i>i</i> _{DR} /d <i>t</i>	100	A/µs	Note *6
Maximum Dawar Dissination	Ptot	263	W	<i>T</i> c=25°C
Maximum Power Dissipation	Ptot	2.78	W	<i>T</i> _a =25°C
Operating Channel Temperature	T _{ch}	150	°C	
Storage Temperature	T _{stg}	-55 to +150	°C	

Note *1 : Maximum duty cycle D=0.53

Note 1. Maximum duty cycle D=0.30Note 2: Limited by maximum channel temperature. Note 3: $T_{ch} \le 150$ °C, See Figure 1 and 2. Note 4: Starting $T_{ch} = 25$ °C, $I_{AS} = 3$ A, L = 165 mH, $V_{DD} = 60$ V, $R_{G} = 50$ Ω , See Figure 1 and 2. Eas limited by maximum channel temperature and avalanche current.

EAS Illillied by Histarillian Grainfel Ching-Cartains and Sciences 2. Note *5: Jor ≤32.8 A , -dios/dt ≤ 100 A/ys, Vbs peak ≤ 600 V, 7ch ≤ 150 °C. Note *6: Jor ≤32.8 A , dv/dt ≤ 30 V/ns, Vbs peak ≤ 600 V, 7ch ≤ 150 °C.

http://www.fujielectric.com/products/semiconductor/

■ Electrical Characteristics at *T*_c=25°C (unless otherwise specified) • Static characteristics

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V I _D = 250 μA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$ $I_D = 5.6 \text{ mA}$		3.0	4.0	5.0	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 600 V V _{GS} = 0 V	T _{ch} = 25 °C	-	-	25	μΑ
		V _{DS} = 480 V V _{GS} = 0 V	T _{ch} = 125 °C	-	-	-	
Gate-Source Leakage Current	I GSS	V _{DS} = 0 V V _{GS} = ± 30 V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 9.3 A		-	0.083	0.093	Ω
Gate resistance	r _g	f = 1 MHz, open drain		-	7.2	-	Ω

• Dynamic characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	g fs	V _{DS} = 25 V I _D = 18.6 A	7.5	30	-	S
Input Capacitance	Ciss	V _{DS} = 400 V	-	1950	-	
Output Capacitance	Coss	V _{GS} = 0 V	-	67	-	
Reverse Transfer Capacitance	Crss	f = 250 kHz	-	8.6	-	
Effective output capacitance, energy related (Note *7)	C _{o(er)}	V _{DS} = 0400 V V _{GS} = 0 V	-	160	-	pF
Effective output capacitance, time related (Note *8)	C _{o(tr)}	$V_{DS} = 0400 \text{ V}$ $V_{GS} = 0 \text{ V}$ $I_D = \text{constant}$	-	660	-	
Turn-On Time	t _{d(on)}	$V_{\rm DD}$ = 400 V, $V_{\rm GS}$ = 10 V $I_{\rm D}$ = 18.6 A,	-	31	-	ns
	t r		-	20	-	
Turn-Off Time	t _{d(off)}	$R_{\rm G}$ = 18 Ω See Figure 3 and 4	-	247	-	
	t f		-	23	-	
Total Gate Charge	Q _G	$V_{\rm DD}$ = 400 V, $V_{\rm GS}$ = 10 V $I_{\rm D}$ = 37.1 A See Figure 5	-	93	-	
Gate-Source Charge	Q _{GS}		-	31	-	nC
Gate-Drain Charge	Q _{GD}		-	43	-	

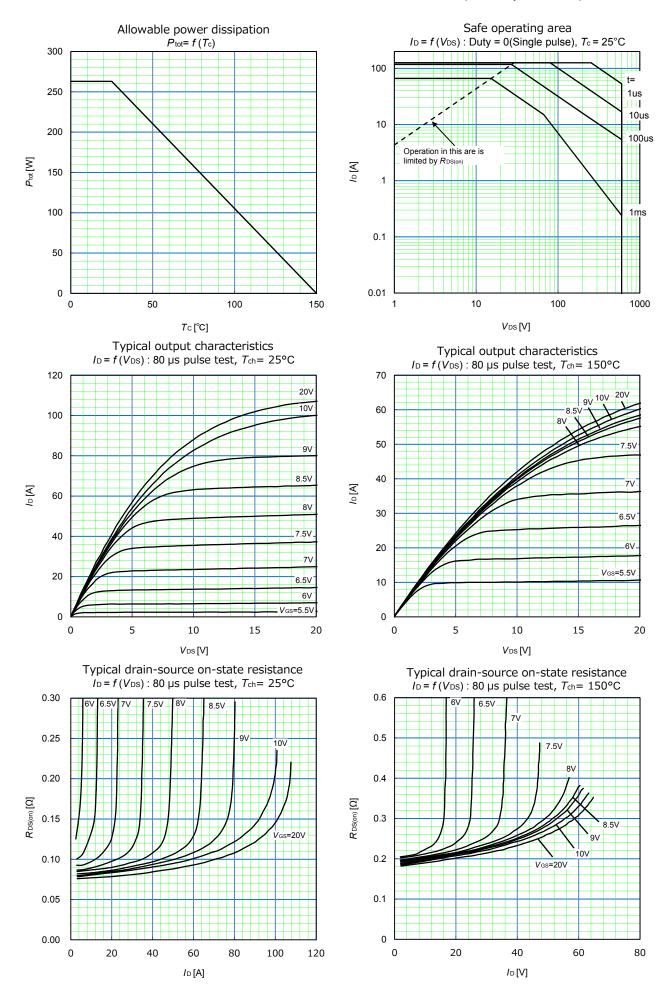
Note *7 : $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400 V. Note *8 : $C_{\text{o(er)}}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400 V.

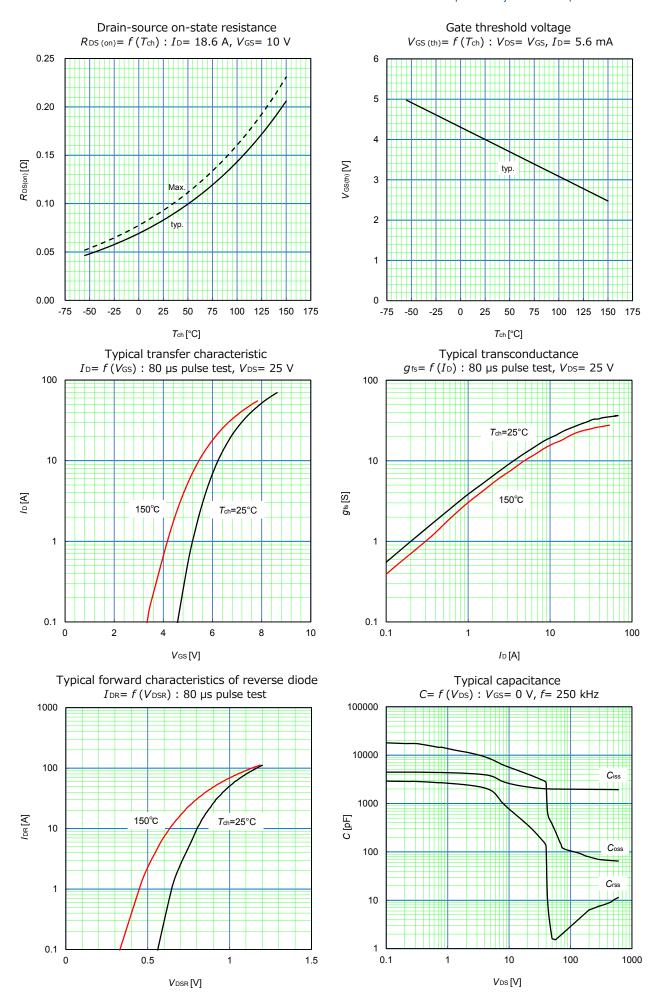
• Reverse diode characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	V _{DSR}	I _{DR} = 37.1 A, V _{GS} = 0 V T _{ch} = 25 °C	-	1.00	1.35	V
Reverse Recovery Time	t rr	V _{DD} = 400 V I _{DR} = 37.1 A V _{GS} = 0 V -di _{DR} /dt = 100 A/µs T _{ch} = 25 °C See Figure 6 and 7	-	190	-	ns
Reverse Recovery Charge	Qrr		-	1.6	-	μC
Peak Reverse Recovery Current	I _{rrm}		-	16	-	Α

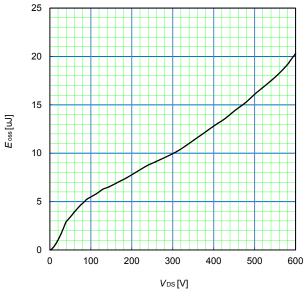
■ Thermal Resistance

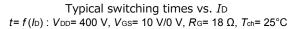
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Channel – Ambient	R _{th(ch-a)}	Device mounted on PCB (FR4) Size: 40mm*40mm*1.5mm with 6cm² copper area (one layer, 70µm thickness) for drain connection and cooling.	-	-	45	°C/W
Thermal Resistance, Channel – Case	R _{th(ch-c)}		-	-	0.475	°C/W

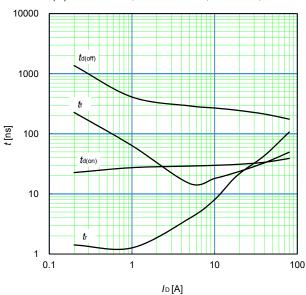




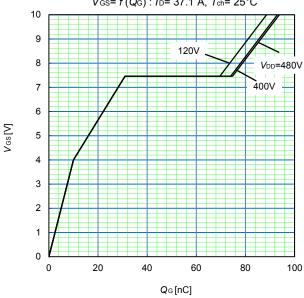




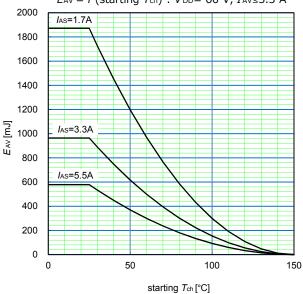




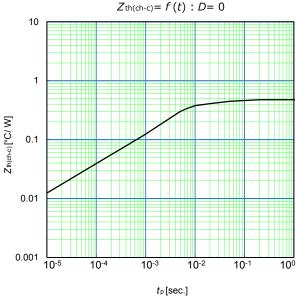
Typical gate charge $V_{GS} = f(Q_G)$: $I_D = 37.1$ A, $T_{Ch} = 25$ °C



Maximum Avalanche Energy $E_{\text{AV}} = f \text{ (starting } T_{\text{ch}}) : V_{\text{DD}} = 60 \text{ V, } I_{\text{AV}} \le 5.5 \text{ A}$



Transient Thermal Impedance $Z_{th(ch,c)} = f(t) : D = 0$



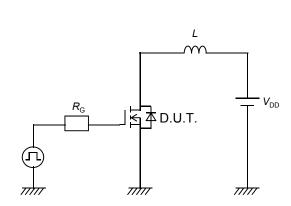


Figure 1. Unclamped inductive load test circuit

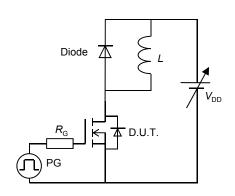


Figure 3. Switching test circuit

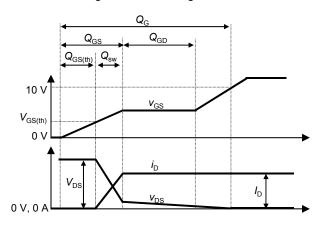
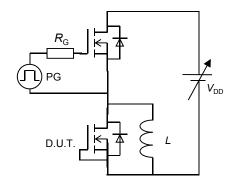


Figure 5. Gate charge waveform



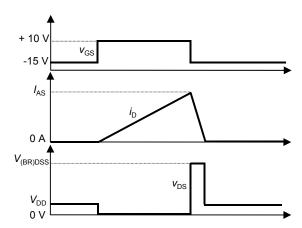


Figure 2. Unclamped inductive waveform

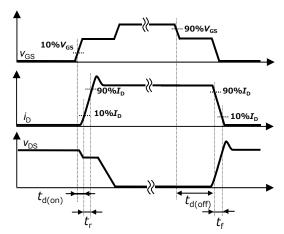
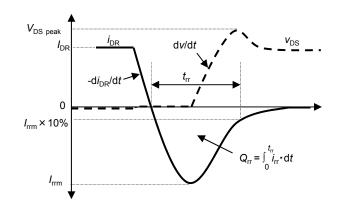
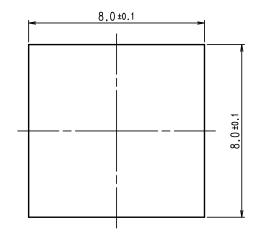


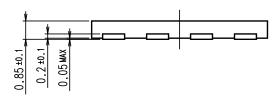
Figure 4. Switching times waveform

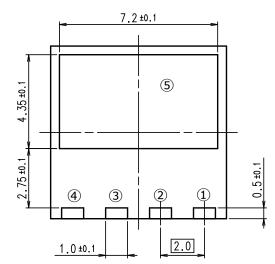


■ Package Dimensions : DFN8x8 Package









CONNECTION

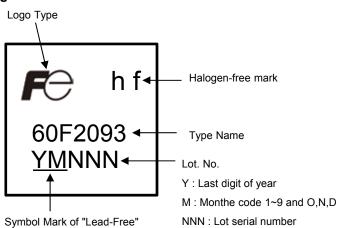
- ① Gate
- 2 Sub-Source for Gate Drive
- 3,4 Source
- **5** DRAIN

DIMENSIONS ARE IN MILLIMETERS

Notes

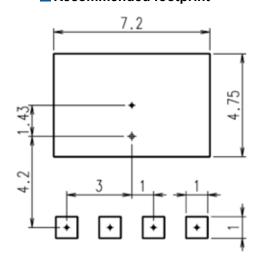
- 1.(): Reference dimensions.
- 2. The metal part is covered with the solder plating, part of cutting is without the solder plating.

Marking



* The font (font type,size) and the trademark-size might be actually different.

■ Recommended footprint



http://www.fujielectric.com/products/semiconductor/

WARNING

- 1. This Catalog contains the product specifications, characteristics, data, materials, and structures as of November 2017.

 The contents are subject to change without notice for specification changes or other reasons. When using a product listed in this Catalog, be sur to obtain the latest specifications.
- 2. All applications described in this Catalog exemplify the use of Fuji's products for your reference only. No right or license, either express or implied, under any patent, copyright, trade secret or other intellectual property right owned by Fuji Electric Co., Ltd. is (or shall be deemed) granted. Fuji Electric Co., Ltd. makes no representation or warranty, whether express or implied, relating to the infringement or alleged infringement of other's intellectual property rights which may arise from the use of the applications described herein.
- 3. Although Fuji Electric Co., Ltd. is enhancing product quality and reliability, a small percentage of semiconductor products may become faulty. When using Fuji Electric semiconductor products in your equipment, you are requested to take adequate safety measures to prevent the equipment from causing a physical injury, fire, or other problem if any of the products become faulty. It is recommended to make your design failsafe, flame retardant, and free of malfunction.
- 4. The products introduced in this Catalog are intended for use in the following electronic and electrical equipment which has normal reliability requirements.
 - Computers
- OA equipment
- Communications equipment (terminal devices)
- Measurement equipment

- Machine tools
- Audiovisual equipment
- Electrical home appliances •
- 5. If you need to use a product in this Catalog for equipment requiring higher reliability than normal, such as for the equipment listed below, it is imperative to contact Fuji Electric Co., Ltd. to obtain prior approval. When using these products for such equipment, take adequate measures such as a backup system to prevent the equipment from malfunctioning even if a Fuji's product incorporated in the equipment becomes faulty.
- Transportation equipment (mounted on cars and ships)
- Traffic-signal control equipment
- Emergency equipment for responding to disasters and anti-burglary devices
- Medical equipment

- Trunk communications equipment
- Gas leakage detectors with an auto-shut-off feature
- Safety devices
- 6. Do not use products in this Catalog for the equipment requiring strict reliability such as the following and equivalents to strategic equipment (without limitation).
- Space equipmentSubmarine repeater equipment
- Aeronautic equipment
- Nuclear control equipment
- 7. Copyright ©1996-2017 by Fuji Electric Co., Ltd. All rights reserved.

No part of this Catalog may be reproduced in any form or by any means without the express permission of Fuji Electric Co., Ltd.

8. If you have any question about any portion in this Catalog, ask Fuji Electric Co., Ltd. or its sales agents before using the product.

Neither Fuji Electric Co., Ltd. nor its agents shall be liable for any injury caused by any use of the products not in accordance with instructions set forth herein.